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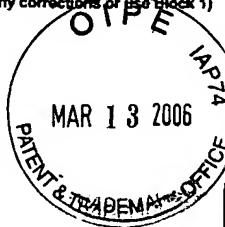
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W. DANIEL SWAYZE, JR.  
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Shannon Trotter (Depositor's name)  
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3/13/06 (Date)

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/612,129	7/2/2003	Chee K. Yew	TI-26239.1	3928

TITLE OF INVENTION: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE

APPLN. TYPE	SMALL ENTITY	ISSUE FEE	PUBLICATION FEE	TOTAL FEE(S) DUE	DATE DUE
nonprovisional	NO	\$1400	\$300	\$1700	03/28/2006

EXAMINER	ART UNIT	CLASS-SUBCLASS
Cao, Phat X.	2814	257-668000

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1 W. Daniel Swayze, Jr.  
2 W. James Brady  
3 Frederick J. Telecky, Jr.

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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of:

First Inventor: Yew

Docket Number: TI-26239.1

Serial No.: 10/612,129

Art Unit: 2814

Filed: 7/2/2003

Examiner: Cao, Phat X.

For: DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE

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<b>NAME OF INVENTOR(S):</b> Yew	
<b>RECEIPT DATE &amp; SERIAL NO.:</b> <b>Serial No.: 10/612,129</b>	
<b>TITLE OF INVENTION:</b> DIRECT ATTACHMENT OF SEMICONDUCTOR CHIP TO ORGANIC SUBSTRATE	
<b>Filing Date:</b> 7/2/2003	
<b>TI FILE NO.:</b> <b>TI-26239.1</b>	<b>DEPOSIT ACCT. NO.:</b> <b>20-0668</b>
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